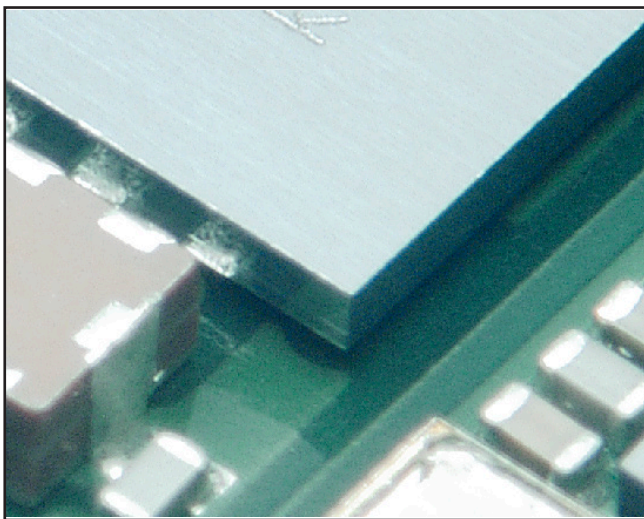


IONOX® I3302

Broad Spectrum Electronics Cleaner

IONOX I3302 is a semi-aqueous cleaning agent designed for cleaning the most challenging SMT Pb-free solder paste and tack flux paste residues. This solution is also safe and effective for use on the newest Sn/Bi solder paste formulas. I3302 is environmentally friendly and can be used in immersion agitation, ultrasonic or centrifugal systems. I3302 is effective for the removal of virtually all types of fluxes including rosin, low residue/no-clean and organic acid flux.



- **Successful in immersion applications**
- **Effectively removes a wide range of soils**
- **Compatible with most materials of construction and metallic alloys**
- **Complete water solubility**
- **Rinse with DI water or IPA**
- **Long bath life**

PRODUCT PROPERTIES

pH	NA
FLASH POINT	180°F / 82°C
BOILING POINT (TCC)	302°F / 150°C
WATER SOLUBLE	Complete
VOC	1035 g/L

TYPICAL PROCESSES

APPLICATION	Immersion
CONCENTRATION	100%
TEMPERATURE	<140°F / 60°C
RINSE	Hot DI Water Rinse
DRY	Hot Air

The above process parameters are recommendations based on extensive testing done in KYZEN's application lab. Your KYZEN sales representative can assist you in optimizing your process parameters.

STORAGE AND HANDLING

- Packaged in Polyethylene Containers
- Store at 5-30°C/41-86°F in Original Container
- Standard Chemical Handling Practices
- Shelf Life of 5 Years, in Sealed Containers of 5 gallons / 25 liters or more

AVAILABILITY

- | | |
|--------------|---------------|
| • 1 Gallon | • 5 Liters* |
| • 5 Gallons | • 25 Liters* |
| • 55 Gallons | • 200 Liters* |

* Liters Available in South Asia and Europe

IONOX® I3302

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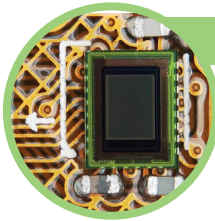
ENVIRONMENTAL, HEALTH AND SAFETY REGULATIONS



IONOX I3302 is a non-hazardous, biodegradable, non-corrosive solvent. It contains no CFCs or HAPs. Refer to the Safety Data Sheet for more information.

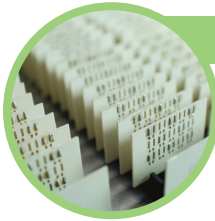
REACH ✓ KYZEN is an ISO 9001:2016 Certified Company

COMPATIBILITY



IONOX I3302 is compatible with all materials commonly used in electronic assembly manufacturing and cleaning processes. For specific compatibility information, please contact your KYZEN representative.

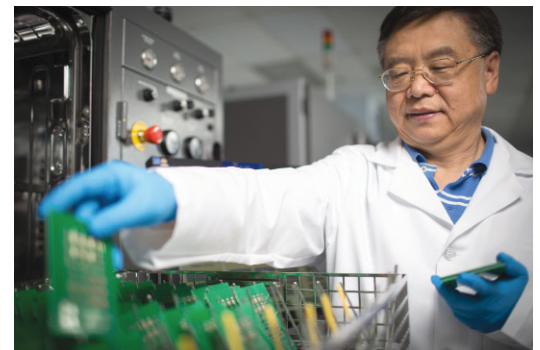
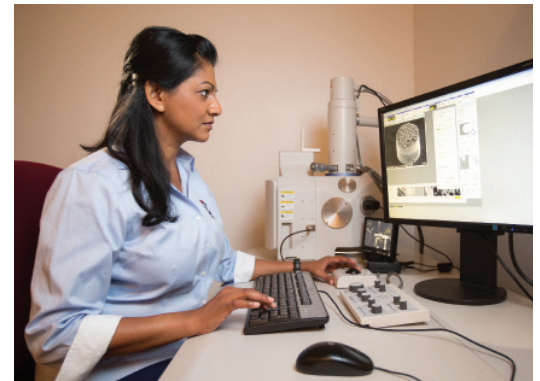
FREE CLEANING TRIALS AND PROCESS OPTIMIZATIONS



KYZEN will conduct complimentary trials at your factory or “risk-free” testing in one of our global Applications Laboratories in North America, Asia or Europe to ensure you achieve your goal. Increase your yields and product reliability by identifying and tuning the critical parameters of your cleaning process. With our commitment to science and understanding process, KYZEN has the flexibility to simulate and refine any cleaning process.

Each laboratory is fully equipped with an extensive array of cleaning and analytical equipment, including, but not limited to:

- Batch Washers
- In-Line Washers
- Ultrasonic Systems
- SUI Systems
- Vapor Degreasers
- GC (TCD and FID)
- Scanning Electron Microscope (SEM)
- Ion Chromatography
- FTIR Spectrophotometer
- Humidity Chamber
- High Powered Microscopes



**Aqueous, Semi-Aqueous and Vapor Phase Chemistries • Process Evaluation and Optimization
Contract Cleaning • Cleanliness Testing • Soil Analysis**

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